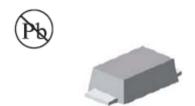


Surface Mount Super Fast Recovery Rectifiers

Features

- Glass passivated chip junctions
- Ideal for automated placement
- Ultrafast reverse recovery time for high efficiency
- Low profile package
- · High forward surge capability
- High temperature soldering:
 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC



Mechanical Date

 Case: JEDEC MSMA molded plastic body over glass passivated chip

 Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D

• Polarity: Laser band denotes cathode end

Major Ratings and Characteristics

I _{F(AV)}	0.5 A
V _{RRM}	50 V to 600 V
I _{FSM}	15 A
t _{rr}	35 nS
V _F	0.95 V, 1.25 V, 1.7 V
T _j max.	150 °C

Maximum Ratings & Thermal Characteristics

(T_A = 25 °C unless otherwise noted)

Items	Symbol	MASF 0.5A	MASF 0.5B	MASF 0.5C	MASF 0.5D	MASF 0.5E	MASF 0.5G	MASF 0.5J	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current	$I_{F(AV)}$	0.5					Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	15					Α		
Thermal resistance from junction to lead ⁽¹⁾	$R_{\theta JL}$	35					°C/W		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150					$^{\circ}$		

Note 1: Mounted on P.C.B. with 0.2 x 0.2" (5.0 x 5.0mm) copper pad areas.

Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Items	Test conditions		Symbol	MASF0.5A ~ MASF0.5D	MASF0.5E~ MASF0.5G	MASF0.5J	UNIT
Instantaneous forward voltage	I _F =0.5A ⁽²⁾		V_{F}	0.95	1.25	1.70	V
Reverse current	V _R =V _{DC}	T _j =25℃ T _j =125℃	I _R	5 100			μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$		t _{rr}	35			nS
Typical junction capacitance	4.0V,1.0MHz		CJ	10			pF

Note 2: Pulse test:300µs pulse width,1% duty cycle.



0

30

Surface Mount Super Fast Recovery Rectifiers

Characteristic Curves (T_A=25 °C unless otherwise noted)

Fig.1 Forward Current Derating Curve

0.5

(X) Days O.3

0.2

0.1

0.1

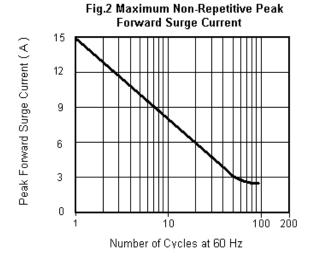
60

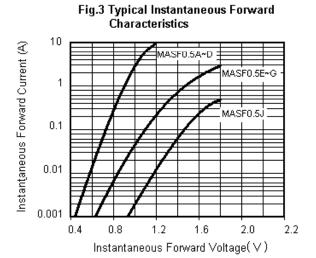
90

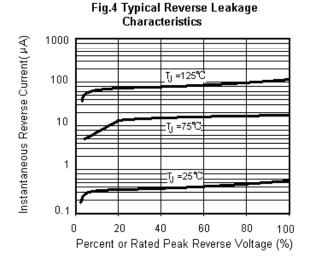
Lead Temperature (℃)

150

120



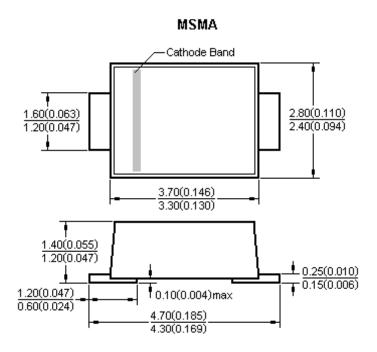






Surface Mount Super Fast Recovery Rectifiers

Package Outline



Dimentsions in millimeters and (inches)

Notice

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage.or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
 - $I_{\text{F(AV)}}\!:\!\text{We recommend}$ that the worst case current be no greater than 80% .
 - I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which the general during the lifespan of the device.
 - T_J : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_J of below 125°C.
- TRR is registered trademark of Rising-sun Technology. Rising-sun Technology reserves the right to make changes to any product in this
 specification to improve reliability, functional characteristics, or design without notice.
- Rising-sun Technology does not assure any liability arising out of the applications or any product described in this specification.
- Rising-sun Technology advises customers to obtain the latest version of the device information before placing orders to verify that the
 required information is current.

